ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNATIONAL AND ADDRESS INDUSTRIES®	PC. Bannockl	burn. Illinois. A	ll rights reserved utions.	under both	This docum level parts, t	ent is a declara	tion of the s encompasse	ubstances es all lowe	within the 1 r level mate	nanufacture rials for wh	er listed iten ich the man	n. Note: if ufacturer	f the item is an as has engineering	sembly with lowe responsibility.
	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	als and Mfg Information			
Supplier Information														
Company name* Comp			Company unique ID			Unique ID Authority					Response Date*			
onsemi	semi										2024-05-17			
Contact Name	ct Name Title - Contact				Phone - Contact*						Email - Contact*			
Product-Env-Stewards Product Env			viro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repres			sentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Dat	e Version]	Manufacturing Site		We	ight*	UOM	Unit Type
	NTMFS	MFS5C430NLT1G NFET SO8FL 40		V 200A 1.5MO	200A 1.5MOH 2			1	MYE		100).77	mg	Each
Manufacturing Proccess Informa	tion							·			·			
Terminal Plating / Grid Array M	terial Terminal Base Alloy		Alloy	J-STD-020 MS	ASL Rating Pea		ak Process Body Temperature Max Time at Peal		ne at Peak T	Temperature Number of		er of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		seconds	3		
comments														
evel 1 - maximum time at peak temperatu	ire during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	4.8	mg	Supplier	Zinc (Zn)	7440-66-6		0.0058	mg
			Supplier	Iron (Fe)	7439-89-6		0.1128	mg
			Supplier	Copper (Cu)	7440-50-8		4.68	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0014	mg
Die	2.0	mg	Supplier	Silicon (Si)	7440-21-3		2	mg
Die Attach Solder	2.33	mg	Supplier	Silver (Ag)	7440-22-4		0.0582	mg
			А	Lead (Pb)	7439-92-1	7a	2.1553	mg
			Supplier	Tin (Sn)	7440-31-5		0.1165	mg
Lead Frame	47.6	mg	Supplier	Silver (Ag)	7440-22-4		0.0048	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0952	mg
			Supplier	Iron (Fe)	7439-89-6		1.2371	mg
			Supplier	Copper (Cu)	7440-50-8		46.1915	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0714	mg
Mold Compound-Black	42.24	mg		Epoxy resin	proprietary data		3.168	mg
			Supplier	Phenolic Resin	Proprietary Data		1.056	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.168	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2112	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		34.6368	mg
Plating	1.7	mg	Supplier	Tin (Sn)	7440-31-5		1.7	mg
Wire Bond - Cu	0.1	mg	Supplier	Copper (Cu)	7440-50-8		0.1	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).